AUTOMOTIVE GRADE

Available

COMPLIANT

HALOGEN FREE



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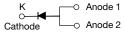
Vishay General Semiconductor

High Current Density Surface Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low $V_F = 0.6 \text{ V}$ at $I_F = 5 \text{ A}$



SMPC (TO-277A)



LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS			
I _{F(AV)}	10 A		
V_{RRM}	200 V		
I _{FSM}	180 A		
V _F at I _F = 10 A	0.68 V		
T _J max.	175 °C		
Package	SMPC (TO-277A)		
Circuit configuration	Single		

FEATURES

- Very low profile typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- · Low forward voltage drop, low power losses
- · High efficiency operation
- MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code; base P/NHM3
- · Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA

Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 -

halogen-free, RoHS-compliant and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V10P22	UNIT	
Device marking code		V1022		
Maximum repetitive peak reverse voltage	V_{RRM}	200	V	
Maximum avarage forward restified current (fig. 1)	I _{F(AV)} (1)	10	^	
Maximum average forward rectified current (fig. 1)	I _{F(AV)} (2)	3.1	A	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	180	А	
Operating junction temperature range	T _J ⁽³⁾	-40 to +175	°C	
Storage temperature range	T _{STG}	-55 to +175	°C	

Notes

- $^{(1)}$ Mounted on 30 mm x 30 mm pad ares aluminum PCB
- (2) Free air, mounted on recommended pad area
- (3) The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta,IA}$



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 5 A	T _A = 25 °C	V _F ⁽¹⁾	0.75	-	V
	I _F = 10 A			0.82	0.9	
	I _F = 5 A	- T _A = 125 °C		0.60	-	
	I _F = 10 A			0.68	0.76	
Reverse current	V _R = 160 V	T _A = 25 °C	I _R ⁽²⁾	0.001	-	mA
	V _R = 100 V	T _A = 125 °C		1	-	
	V _R = 200 V	T _A = 25 °C		-	0.15	
	v _R = 200 v	T _A = 125 °C		2.5	10	
Typical junction capacitance	4.0 V, 1 MHz	4.0 V, 1 MHz		500	-	pF

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise specified)			
PARAMETER	SYMBOL	V10P22	UNIT
Typical thermal resistance	R _{0JA} (1)(2)	80	°C/W
	R _{0JM} (3)	4	

Notes

- (1) The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$
- $^{(2)}$ Free air, mounted on recommended copper pad area, 2 oz., FR4 PCB, thermal resistance $R_{\theta JA}$ junction to ambient
- $^{(3)}$ Units mounted on recommended PCB, thermal resistance $R_{\theta JM}$ junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V10P22-M3/H	0.10	Н	1500	7" diameter plastic tape and reel	
V10P22-M3/I	0.10	I	6500	13" diameter plastic tape and reel	
V10P22HM3/H ⁽¹⁾	0.10	Н	1500	7" diameter plastic tape and reel	
V10P22HM3/I (1)	0.10	I	6500	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise specified)

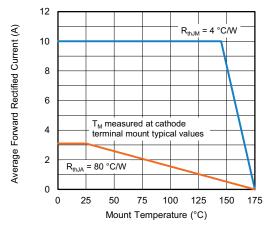


Fig. 1 - Maximum Forward Current Derating Curve

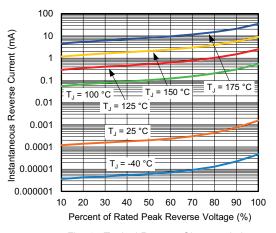


Fig. 4 - Typical Reverse Characteristics

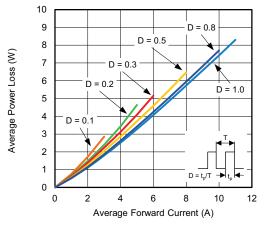


Fig. 2 - Forward Power Loss Characteristics

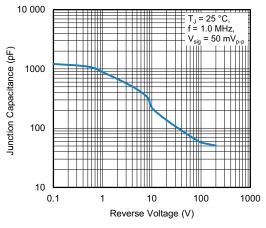


Fig. 5 - Typical Junction Capacitance

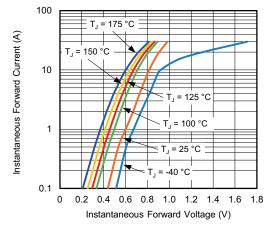


Fig. 3 - Typical Instantaneous Forward Characteristics

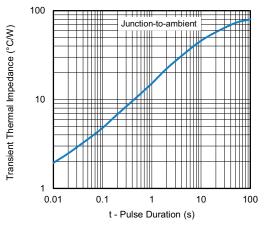
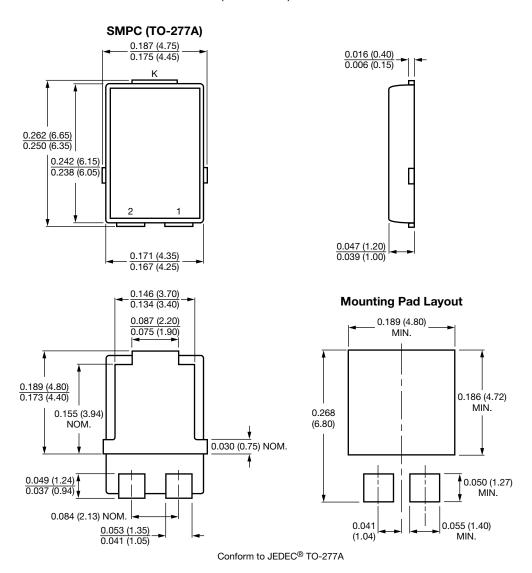


Fig. 6 - Typical Transient Thermal Impedance



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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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